

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Panasonic Chip Bead Array

Chip Bead Array

Type: **EXC28B**

Discontinued

■ Features

- Space saving
- SSOP package (0.5 mm pitch) compatibility
- Small size and lightweight
- RoHS compliant

Type: EXC28BB

- Suitable for high speed signals (over 50 MHz)
- Excellent cross talk characteristics (100 MHz:<-25 dB)

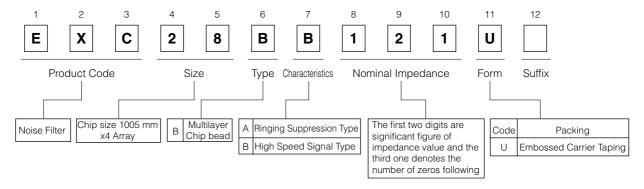
Type: EXC28BA

- Reduces waveform ringing noise
- Excellent cross talk characteristics (100 MHz:<-30 dB)

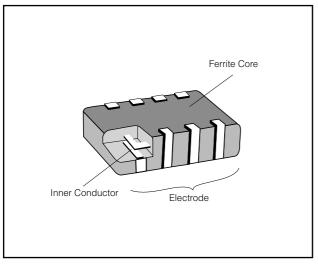
■ Recommended Applications

- Small digital equipment such as PCs, printers, HDD, DVD-ROMs, CD-ROMs, LCDs.
- Digital audio and video equipment such as DSC, DVC, CD Players, DVD Players, MD Players.
- Electronic musical instruments, and other digital equipment.

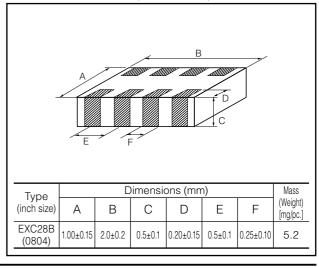
■ Explanation of Part Numbers



■ Construction



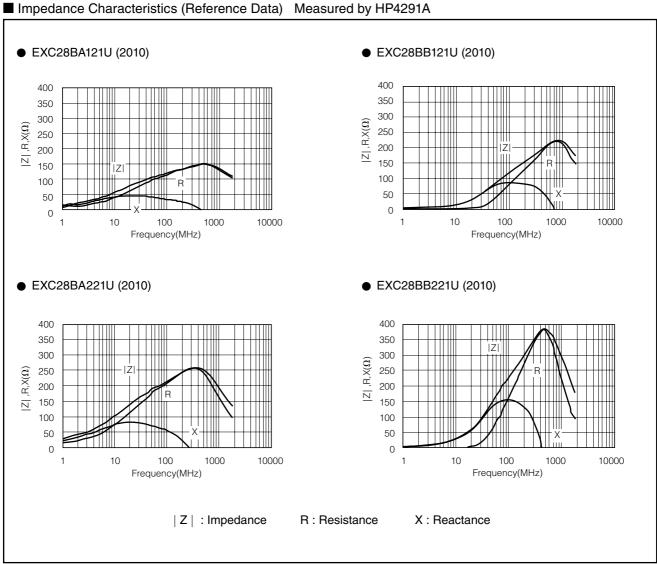
■ Dimensions in mm (not to scale)



Panasonic Chip Bead Array

■ Ratings	Discontinued				
T. 100 0	Dout Number	Impedar	nce	Rated Current	DC Resistance
Type	Part Number	(Ω) at 100MHz	tol.(%)	(mA DC)	(Ω) max.
ВА	EXC28BA121U	120	±25	100	0.5
	EXC28BA221U	220			0.7
ВВ	EXC28BB121U	120			0.5
	EXC28BB221U	220			0.7

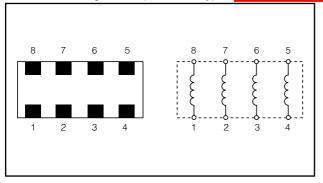
◆ Category Temperature Range –40 °C to +85 °C



Panasonic Chip Bead Array

■ Circuit Configuration(No Polarity)

Discontinued

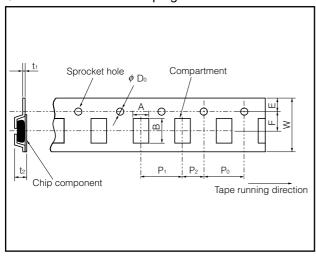


■ Packaging Methods (Taping)

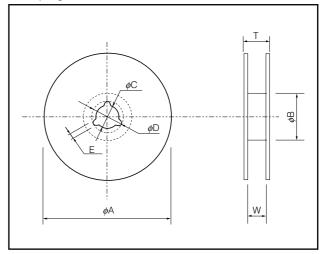
Standard Quantity

Part Number	Kind of Taping	Pitch (P ₁)	Quantity
EXC28B□□□□U	Embossed Carrier Taping	4 mm	5000 pcs./reel

Embossed Carrier Taping



Taping Reel



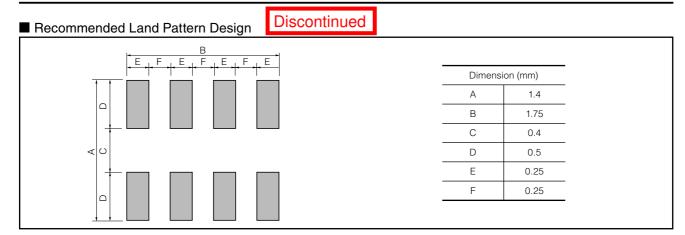
Embossed Carrier Dimensions (mm)

Part Number	А	В	W	F	Е	P ₁	P ₂	P ₀	ϕD_0	t ₁	t ₂
EXC28B□□□□U	1.20±0.15	2.25±0.15	8.0±0.2	3.5±0.1	1.75±0.10	4.0±0.1	2.0±0.1	4.0±0.1	1.5±0.1	0.25±0.05	

Standard Reel Dimensions (mm)

Part Number	ϕ A	φ B	φC	ϕ D	Е	W	T
EXC28B□□□□U	180-3.0	60.0±1.0	13.0±0.5	21.0±0.8	2.0±0.5	9.0±0.3	11.4±1.5

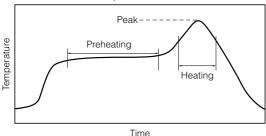
Panasonic Chip Bead Array



■ Recommended Soldering Conditions

Recommendations and precautions are described below.

- Recommended soldering conditions for reflow
- · Reflow soldering shall be performed a maximum of two times.
- · Please contact us for additional information when used in conditions other than those specified.
- Please measure the temperature of the terminals and study every kind of solder and printed circuit board for solderability before actual use.



For soldering (Example: Sn-37Pb)

	Temperature	Time		
Preheating	140 °C to 160 °C	60 s to 120 s		
Main heating	Above 200 °C	30 s to 40 s		
Peak	235 ± 10 °C	max. 10 s		

For lead-free soldering (Example: Sn/3Ag/0.5Cu)

	Temperature	Time		
Preheating	150 °C to 170 °C	60 s to 120 s		
Main heating	Above 230 °C	30 s to 40 s		
Peak	max. 260 °C	max. 10 s		

- Flow soldering
- · We do not recommend flow soldering , because flow soldering may cause bridges between the electrodes.

<Repair with hand soldering>

- Preheat with a blast of hot air or similar method. Use a soldering iron with a tip temperature of 350 °C or less. Solder each electrode for 3 seconds or less.
- Never touch this product with the tip of a soldering iron.

The following are precautions for individual products. Please also refer to the common precautions for Noise Suppression Device shown on this catalog.

- 1. Use rosin-based flux or halogen-free flux.
- 2. For cleaning, use an alcohol-based cleaning agent. Before using any other type, consult with our sales person in advance.
- 3. Do not apply shock to Chip Bead Array (hereafter called the bead arrays) or pinch them with a hard tool (e.g. pliers and tweezers). Otherwise, their bodies may be chipped, affecting their performance. Excessive mechanical stress may damage the bead arrays. Handle with care.
- 4. Store the bead arrays in a location with a temperature ranging from −5 °C to +40 °C and a relative humidity of 40 % to 60 %, where there are no rapid changes in temperature or humidity.
- 5. Use the bead arrays within half a year after the date of the outgoing inspection indicated on the packages.